



June 5, 2006

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/786,807 02/25/2004

H. M. CHEN

"METHOD FOR IMPROVING SEMICONDUCTOR
WAFER TEST ACCURACY"

Grp. Art Unit: 2822

AU, BACH

RESPONSE FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Final Office Action dated January 13, 2006, please amend the above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 8 2006.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date

SEB
5/8/06

Amendments to the Claims are reflected in the listing of the Claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.